

Product Summary Hitachi Deskstar 7K250

Ultra ATA/100 Hard disk drive

Models: HDS722540VLAT20

HDS722580VLAT20 HDS722512VLAT20 HDS722512VLAT80 HDS722516VLAT20 HDS722516VLAT80 HDS722525VLAT80



Introduction

The Hitachi Deskstar 7K250 is ideal for high performance desktop users. These drives feature capacities from 40 GB to 250 GB, a rotational speed of 7200 RPM, and average seek times of 8.2 and 8.5 ms. The Hitachi Deskstar 7K250 combines new and proven technologies to greatly enhance system performance and capacity.

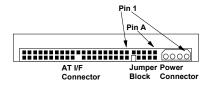
Applications

- Advanced desktop and audio/video
- Low-cost routers
- Switches
- Video editing

Features		Advantages	
•	Formatted capacities of 40, 80, 120, 160 and 250 GB Rotational speed 7200 RPM	•	Supports higher quality digital audio/video storage, superior digital content creation capabilities, and significantly faster processing
•	Ultra ATA/100 interface Self Diagnostics on Power On and resident diagnostics	•	Optimizes system performance
•	Operating shock—No data loss occurs with a 55 G half-sine shock pulse of 2 ms duration	•	Protection for drive mishandling Increased reliability
•	Idle power consumption of 5.0 W(40GB & 80GB), 5.9W (120GB &160GB), 7.0 W(250GB) Circuits and motors optimized to save power and reduce system temperature	•	Lower system power supply and cooling requirements Extending system life and reliability
•	2048 KB data buffer (8192 KB an option for some models) (upper 260 KB for firmware) Media-to-buffer transfer rates: 757 Mb/s Typical seek time(read): 120-250GB – 8.2ms, 40-80GB – 8.5ms Average latency: 4.17 ms Complies with ATA 7 specification	•	Fast access to data Improved throughput
•	Fluid Dynamic Bearing and tri-laminate top cover	•	Lower acoustics

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Connectors



The DC power connector is designed to mate with AMP p/n 1-80424-0 using AMP strip pins (p/n 350078-4), loose piece pins (p/n 61173-4), or their equivalents.

Note: The AT signal connector is a 40-pin connector.

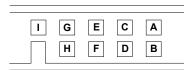
Cabling

The length of the cable from the host system to the drive must not exceed 18 inches.

For systems operating with Ultra DMA mode 3, 4, or 5, the 80-conductor ATA cable assembly must be used.

Jumper block

Jumper pin letter designations



A jumper attaches two pins together to configure the drive for the proper mode of operation.

Jumper settings

16 head logical architecture

Master active*	A-B and G-H
Slave active	A-B and C-D
Cable Select	A-B and E-F
Master/Slave present	E-F and G-H
Reserved	1

15 head logical architecture

Master active	A-C and G-H
Slave active	A-C
Cable select	A-C and E-F
Master/Slave present	A-C, E-F & G-H
Reserved	I

All other jumper settings are reserved. Do not make other settings!

*Shipping default

DC power requirements

Damage to the drive electronics may result if the power supply cable is connected or disconnected while the power is on. There is no special power on/off sequencing required. The following voltage specification is applied at the power connector of the drive.

Input voltage (Volts)	During run and spin up (Volts)	Absolute max spike voltage
+5	5 ± 5%	7 ¹
+12	12 +10% -8%	15 ¹

¹Power supply voltage spikes in excess of the maximum values specified in the table may damage the drive electronics.

Power supply current

	mA RMS		Total
	+5 V	+12V	Watts
250 GB model			
Idle avg	280	470	7.0
Idle ripple – peak to peak	230	330	_
Seek peak	590	1950	-
Seek avg 1	330	690	10.0
Start up-max	870	1840	_
RND R/W peak	790	1800	-
RND R/W avg ²	490	660	10.3
Standby avg	140	20	0.9
Sleep avg	100	20	0.7

120 GB and 160 GB model

ldle avg	280	375	5.9
Idle ripple – p to p	230	250	_
Seek peak	590	1790	-
Seek avg ¹	330	610	6.7
Start up-max	740	1800	_
RND R/W peak	1252	1600	
RND R/W avg ²	430	590	10.1
Standby avg	140	20	0.9
Sleep avg	100	20	0.7

40 GB and 80 GB model

40 GD and 60 GD model			
Idle avg	280	300	5.0
Idle ripple – p to p	230	220	_
Seek peak	600	1550	-
_Seek avg 1	330	520	7.9
Start up-max	870	1700	_
RND R/W peak	1252	1720	-
RND R/W avg ²	430	590	8.3
Standby avg	140	20	0.9
Sleep avg	100	20	0.7

Random seeks at 40% duty cycle

² Seek duty = 30%, W/R duty = 45%, Idle Duty = 25%

Power supply generated ripple

Output (V)	Maximum (mV p-p)	Freq. range (MHz)
+5	100	0–10
+12	150	0–10

Hot Plug/Unplug support

Hot plugging/unplugging is not allowed. Damage to the drive electronics may result if the power supply cable is connected or disconnected while power is being applied to the drive.

Data organization (logical)

Number of heads	16
Sectors/track	63
Number of cylinders	16,383

Capacity (GB)	Total logical data bytes
	27100
40	41,174,178,880
80	82,348,277,760
120	123,522,416,640
160	164,696,555,520
250	250,059,350,016

Electromagnetic compatibility

When installed in a suitable enclosure and exercised with a random accessing routine at the maximum data rate the hard disk drive meets the following worldwide EMC requirements listed below:

- United States Federal Communications Commission (FCC) Rules and Regulations (Class B), Part 15.
- European Economic Community (EEC) directive number 76/889 related to the control of radio frequency interference and the Verband Deutscher Elektrotechniker (VDE) requirements of Germany (GOP).

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Environment				
Operating conditions				
Temperature	5 to 55°C ¹			
Relative humidity (noncondensing)	8 to 90%RH			
Maximum wet bulb temperature (noncondensing)	29.4°C			
Maximum tem- perature gradient	15°C/hour			
Altitude	-300 to 3048 m			

¹The system is responsible for providing sufficient air movement to maintain a surface temperature below 60°C at the center of the top cover of the drive.

Non operating conditions

Temperature	–40 to 65°C
Relative humidity	5 to 95%RH
(noncondensing)	0 10 00 701111
Maximum wet	
bulb temperature	35°C
(noncondensing)	
Altitude	-300 to 12,000m

Operating shock

The drive meets the following criteria while operating in respective conditions described in the list below.

- No error occurs with a 10 G halfsine shock pulse of 11 ms duration in all models.
- No data loss occurs with a 30 G half-sine shock pulse of 4 ms duration in all models.
- No data loss occurs with a 55 G half-sine shock pulse of 2 ms duration in all models.

The shock test consists of ten shocks inputs in each axis and in each direction for a total of 60. There must be a delay between shock pulses that is long enough to allow the drive to complete all of the necessary error recovery procedure.

Nonoperating shock

The drives will operate with no degradation of performance after being subjected to a shock pulses with the following characteristics. The tests involved trapezoidal and sinusoidal shock waye.

Trapezoidal shock wave

- The approximate shape of the pulse is square (trapezoidal).
- Approximate rise and fall time of pulse = 1 ms.

- Average acceleration level = 50 G. (Average response curve value during the time following the 1 ms rise time and before the 1 ms fall with a time duration of 11 ms)
- Minimum velocity change equals 4.23 m/s.

Sinusoidal shock wave

The shape is approximately a halfsine pulse. The following table shows the maximum acceleration level and duration.

	Acceler- ation level (G)	Duration (ms)	
All models	75	11	
	300	2	
	350	2	

Rotational shock

No data loss is incurred with the following rotational shocks applied around the axis of the actuator pivot:

- 30,000 rad/s² for a duration of 1 ms
- 20,000 rad/s² for a duration of 2 ms

Acoustics

The upper limit criteria of the octave sound power levels are given in Bels relative to one pico watt and are shown below. The measurement method is in accordance with ISO7779.

250 GB model

Mode	Typical (Bel)	Max. (Bel)
Idle	3.0	3.4
Operating	·	
Performance seek mode	3.4	3.7
Quiet seek mode	3.1	3.5

120GB and 160GB models

Mode	Typical (Bel)	Max. (Bel)
Idle	2.8	3.2
Operating		
Performance seek mode	3.4	3.7
Quiet seek mode	2.9	3.3

40GB and 80 GB models

Mode	Typical (Bel)	Max. (Bel)
ldle	2.6	3.0
Operating		
Performance seek mode	3.4	3.7
Quiet seek mode	2.8	3.2



ATTENTION: The drive must be protected against electrostatic discharge especially when being handled. The safest way to

avoid damage is to put the drive in an anti-static bag before ESD wrist straps are removed.

Drives must be shipped in approved containers. Severe damage can be caused to the drive if the packaging does not adequately protect against the shock levels induced when a box is dropped. Consult your Hitachi Global Storage Technologies representative if you do not have an approved shipping container.

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Command descriptions

The following commands are supported by the drive:

Commands	(Hex)	P
Check Power Mode	E5	3
Check Power Mode*	98	3
Execute Device		
Diagnostic	90	3
Flush Cache	E7	3
Format Track	50	2
Identify Device	EC	1
Idle	E3	3
Idle*	97	3
Idle Immediate	E1	3
Idle Immediate*	95	3
Initialize Device	91	3
Parameters		
NOP	00	3
Read Buffer	E4	1
Read DMA (retry)	C8	4
Read DMA (no retry)	C9	4
Read DMA Queued	C7 22	5
Read Long (retry)		1
Read long (no retry)	23	1
Read Multiple	C4	1
Read Native Max Address	F8	3
Read Sectors (retry)	20	1
Read Sectors (no	20	<u>'</u>
retry)	21	1
Read Verify Sectors		
(retry)	40	3
Read Verify Sectors	44	
(no retry)	41	3
Recalibrate	1x	3
Security Disable	F6	2
Password	го	
Security Erase	F3	3
Prepare		
Security Erase Unit	F4	2
Security Freeze Lock	F5	3
Security Set	F1	2
Password	1 1	
Security Unlock	F2	2
Seek	7x	3
Service	A2	5
Set Features	EF	3
Set Max Address	F9	3
Set Multiple Mode	C6	3
Sleep	E6	3
Sleep*	99	3
SMART Disable	B0	3
Operations S.M.A.R.T. Enable/		
Disable Attribute Auto	B0	3
save	20	J
S.M.A.R.T. Enable	_	
Operations	В0	3
S.M.A.R.T. Execute		
Off-line Data	В0	3
Collection		

S.M.A.R.T. Read Attribute Values	В0	1
S.M.A.R.T. Read Attribute Thresholds	В0	1
S.M.A.R.T. Return Status	В0	3
S.M.A.R.T. Save Attribute Values	В0	3
S.M.A.R.T. Read Log Sector	В0	1
S.M.A.R.T. Write Log Sector	В0	2
S.M.A.R.T. Enable/ Disable Automatic Off-line Data	В0	3
Collection		
Collection Standby	E2	3
	E2 96	3
Standby		3 3 3
Standby Standby*	96	3 3 3
Standby Standby* Standby Immediate	96 E0	3 3 3 3 2
Standby Standby* Standby Immediate Standby Immediate* Write Buffer Write DMA (retry)	96 E0 94 E8 CA	4
Standby Standby* Standby Immediate Standby Immediate* Write Buffer	96 E0 94 E8 CA	4 4
Standby Standby* Standby Immediate Standby Immediate* Write Buffer Write DMA (retry) Write DMA (no retry) Write DMA Queued	96 E0 94 E8 CA	4 4
Standby Standby* Standby Immediate Standby Immediate* Write Buffer Write DMA (retry) Write DMA (no retry)	96 E0 94 E8 CA CB CC 32	4 4
Standby Standby* Standby Immediate Standby Immediate* Write Buffer Write DMA (retry) Write DMA (no retry) Write DMA Queued Write Long (retry) Write Long (no retry)	96 E0 94 E8 CA CB CC 32	4 4
Standby Standby* Standby Immediate Standby Immediate* Write Buffer Write DMA (retry) Write DMA (no retry) Write DMA Queued Write Long (retry) Write Long (no retry) Write Multiple	96 E0 94 E8 CA CB CC 32 33 C5	4 4
Standby Standby* Standby Immediate Standby Immediate* Write Buffer Write DMA (retry) Write DMA (no retry) Write DMA Queued Write Long (retry) Write Long (no retry)	96 E0 94 E8 CA CB CC 32	4

Protocol

- 1 PIO data IN command
- 2 PIO data OUT command
- 3 Non data command
- 4 DMA command
- 5 DMA queued command
- + Vendor specific command

Note: Commands marked * are alternate command codes for previously defined commands

Signal definition				
Pin	Signal	I/O	Туре	
01	RESET-		(2)	
02	GND	_	_	
03	DD7	I/O	(1)	
04	DD8	I/O	(1)	
05	DD6	I/O	(1)	
06	DD9	I/O	(1)	
07	DD5	I/O	(1)	
08	DD10	I/O	(1)	
09	DD4	I/O	(1)	
10	DD11	I/O	(1)	
11	DD3	I/O	(1)	
12	DD12	I/O	(1)	
13	DD2	I/O	(1)	
14	DD13	I/O	(1)	
15	DD1	I/O	(1)	
16	DD14	I/O	(1)	
17	DD0	I/O	(1)	
18	DD15	I/O	(1)	
19	GND	-	-	
(20)	Key	_	_	
21	DMARQ	0	(1)	
22	GND	_	_	
23	DIOW-(**)	ı	(2)	
24	GND	_	_	
25	DIOR-(**)	l	(2)	
26	GND	-	-	
27	IORDY(**)	0	(1)	
28	CSEL		(2)	
29	DMACK-	ı	(2)	
30	GND	_	_	
31	INTRQ	0	(1)	
32				
33	DA1	I	(2)	
34	PDIAG-	I/O	(3)	
35	DA0	<u> </u>	(2)	
36	DA2	l	(2)	
37	CS0-		(2)	
38	CS1-	<u> </u>	(2)	
39	DASP-	I/O	(3)	
40	GND	_	_	

Notes:

Type:

- (1) 3-state
- (2) TTL
- (3) open-collector or open drain output

O – an output from the drive.

I - an input to the drive.

"I/O" designates an input/output common.

The signal lines marked with (**) are redefined during the Ultra DMA protocol to provide special functions. These lines change from the conventional to special definitions at the moment the Host decides to allow a DMA burst if the Ultra DMA transfer mode was previously chosen by means of SetFeatures. The Drive becomes aware of this change upon assertion of the DMACK- line. These lines revert back to their original

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definitions upon the deassertion of DMACK— at the termination of the DMA burst. See the table below.

Ultra DMA definitions

	Special definition (for Ultra DMA)	Conventional definition
	DDMARDY-	IORDY
Write	HSTROBE	DIOR-
	STOP	DIOW-
	HDMARDY -	DIOR-
Read	DSTROBE	IORDY
	STOP	DIOW-

Mechanical data

Height	25.4 mm ± 0.4
Width	101.6 mm ± 0.4
Length	146.0 mm ± 0.6

Weight (maximum)	640 grams
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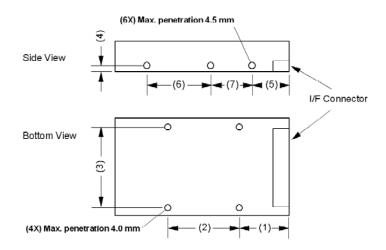
Mounting

The drive will operate in all axes (six directions). Performance and error rate will stay within specification limits if the drive is operated in the other permissible orientations from which it was formatted.

For reliable operation the drive must be mounted in the system securely enough to prevent damage from excessive motion or vibration during seek operation or spindle rotation, using appropriate screws or equivalent mounting hardware.

Drive level vibration test and shock test are to be conducted with the drive mounted to the table using the bottom four screws.

Mounting holes



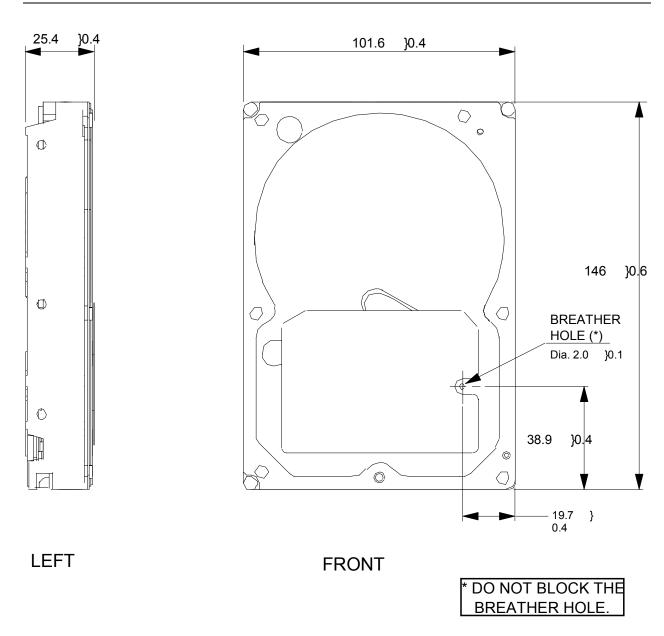
Dimension reference number	(1)	(2)	(3)	(4)	(5)	(6)	(7)
Dimension (mm)	41.28 ± 0.5	44.45 ± 0.2	95.25 ± 0.2	6.35 ± 0.2	28.5 ± 0.5	60.0 ± 0.2	41.6 ± 0.2

Mounting screw thread count = 6-32 UNC

Notes: Recommended screw torque to be applied to mounting screws is 0.6–1.0 Nm (6–10 kg-cm).

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Mechanical dimensions



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Produced in the United States

7/03

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22 July 2003